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Details

Product Status	Obsolete
Core Processor	-
Core Size	-
Speed	-
Connectivity	-
Peripherals	-
Number of I/O	-
Program Memory Size	-
Program Memory Type	-
EEPROM Size	-
RAM Size	-
Voltage - Supply (Vcc/Vdd)	-
Data Converters	-
Oscillator Type	-
Operating Temperature	-
Mounting Type	-
Package / Case	-
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/m30281f8hp

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1.2 Performance Overview

Table 1.1 and **1.2** outline performance overview of the M16C/28 Group (M16C/28, M16C/28B).

Table 1.1 M16C/28 Group (M16C/28, M16C/28) Performance (80/85-Pin Package)

	Item	Performance
CPU	Number of basic instructions	91 instructions
	Minimum instruction execution time	41.7 ns (f(BCLK) = 24 MHz, Vcc = 4.2 V to 5.5 V) (M16C/28B) 50 ns (f(BCLK) = 20 MHz, Vcc = 3.0 V to 5.5 V) (M16C/28, M16C/28B) 100 ns (f(BCLK) = 10 MHz, Vcc = 2.7 V to 5.5 V) (M16C/28, M16C/28B)
	Operation mode	Single chip mode
	Address space	1M bytes
	Memory capacity	See Table 1.3
Peripheral Function	I/O port	Input/Output : 71 lines
	Multifunction timer	TimerA:16 bits x 5 channels, TimerB:16 bits x 3 channels Three-phase Motor Control Timer TimerS (Input Capture/Output Compare) : 16bit base timer x 1 channel (Input/Output x 8 channels)
	Serial I/O	2 channels (UART0, UART1) UART, clock synchronous 1 channel (UART2) UART, clock synchronous, I ² C bus ⁽¹⁾ , or IEBus ⁽²⁾ 2 channels (SI/O3, SI/O4) Clock synchronous 1 channel (Multi-Master I ² C bus ⁽¹⁾)
	A/D converter	10 bits x 24 channels
	DMAC	2 channels
	Watchdog timer	15 bits x 1 (with prescaler)
	Interrupt	25 internal and 8 external sources, 4 software sources, 7 levels
	Clock generation circuit	4 circuits • Main clock (*) • Sub-clock (*) • On-chip oscillator • PLL frequency synthesizer (*) Equipped with a built-in feedback resistor
	Oscillation Stop Detect Function	Main clock oscillation stop, re-oscillation detect function
	Voltage detection circuit	Available
Electrical Characteristics	Power supply voltage	Vcc = 4.2 V to 5.5 V (f(BCLK) = 24 MHz) (M16C/28B) Vcc = 3.0 V to 5.5 V (f(BCLK) = 20 MHz) (M16C/28, M16C/28B) Vcc = 2.7 V to 5.5 V (f(BCLK) = 10 MHz) (M16C/28, M16C/28B)
	Power consumption	16 mA (Vcc = 5V, f(BCLK) = 20 MHz) 25 μ A (f(XCIN) = 32 KHz on RAM) 3.0 μ A (Vcc = 3V, f(XCIN) = 32 KHz, in wait mode) 0.7 μ A (Vcc = 3V, in stop mode)
Flash Memory	Program/erase supply voltage	2.7 V to 5.5 V
	Program and erase endurance	100 times (all space) or 1,000 times (Blocks 0 to 5) /10,000 times (Block A, Block B ⁽³⁾)
Operating Ambient Temperature		-20 to 85°C/-40 to 85°C ⁽³⁾
Package		80-pin plastic mold LQFP, 85-pin plastic mold TFLGA

NOTES:

1. I²C bus is a trademark of Koninklijke Philips Electronics N. V.
2. IEBus is a trademark of NEC Electronics Corporation.
3. Refer to **Table 1.5** to **1.7** for number of program/erase.
4. Use PLL frequency synthesizer to use M16C/28B at f(BCLK) = 24 MHz.

Table 1.2 M16C/28 Group (M16C/28, M16C/28B) (64-Pin Package)

	Item	Performance
CPU	Number of basic instructions	91 instructions
	Minimum instruction execution time	41.7 ns ($f(\text{BCLK}) = 24 \text{ MHz}$, $V_{CC} = 4.2 \text{ V to } 5.5 \text{ V}$) (M16C/28B) 50 ns ($f(\text{BCLK}) = 20 \text{ MHz}$, $V_{CC} = 3.0 \text{ V to } 5.5 \text{ V}$) (M16C/28, M16C/28B) 100 ns ($f(\text{BCLK}) = 10 \text{ MHz}$, $V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$) (M16C/28, M16C/28B)
	Operation mode	Single chip mode
	Address space	1M bytes
	Memory capacity	See Table 1.3
Peripheral Function	I/O Port	Input/Output : 55 lines
	Multifunction timer	TimerA:16 bits x 5 channels, TimerB:16 bits x 3 channels Three-phase Motor Control Timer TimerS (Input Capture/Output Compare) : 16bit base timer x 1 channel (Input/Output x 8 channels)
	Serial I/O	2 channels (UART0, UART1) UART, clock synchronous 1 channel (UART2) UART, clock synchronous, I ² C bus ⁽¹⁾ , or IEBus ⁽²⁾ 1 channels (SI/O3, SI/O4) Clock synchronous 1 channel (Multi-Master I ² C bus ⁽¹⁾)
	A/D converter	10 bits x 13 channels
	DMAC	2 channels
	Watchdog timer	15 bits x 1 (with prescaler)
	Interrupt	24 internal and 8 external sources, 4 software sources, 7 levels
	Clock generation circuit	4 circuits • Main clock(*) • Sub-clock(*) • On-chip oscillator • PLL frequency synthesizer (*) Equipped with a built-in feedback resistor
	Oscillation Stop Detect Function	Main clock oscillation stop, re-oscillation detect function
	Voltage detection circuit	Available
Electrical Characteristics	Power supply voltage	$V_{CC} = 4.2 \text{ V to } 5.5 \text{ V}$ ($f(\text{BCLK}) = 24 \text{ MHz}$) (M16C/28) $V_{CC} = 3.0 \text{ V to } 5.5 \text{ V}$ ($f(\text{BCLK}) = 20 \text{ MHz}$) (M16C/28, M16C/28B) $V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$ ($f(\text{BCLK}) = 10 \text{ MHz}$) (M16C/28, M16C/28B)
	Power consumption	16 mA ($V_{CC} = 5 \text{ V}$, $f(\text{BCLK}) = 20 \text{ MHz}$) 25 μA ($f(\text{XCIN}) = 32 \text{ KHz}$ on RAM) 3.0 μA ($V_{CC} = 3 \text{ V}$, $f(\text{XCIN}) = 32 \text{ KHz}$, in wait mode) 0.7 μA ($V_{CC} = 3 \text{ V}$, in stop mode)
Flash Memory	Program/erase supply voltage	2.7 V to 5.5 V
	Program and erase endurance	100 times (all space) or 1,000 times (Blocks 0 to 5) /10,000 times (Block A, Block B ⁽³⁾)
Operating Ambient Temperature		-20 to 85°C/-40 to 85°C ⁽³⁾
Package		64-pin plastic mold LQFP

NOTES:

1. I²C bus is a trademark of Koninklijke Philips Electronics N. V.
2. IEBus is a trademark of NEC Electronics Corporation.
3. Refer to **Table 1.5 to 1.7** for number of program/erase.
4. Use PLL frequency synthesizer to use M16C/28B at $f(\text{BCLK}) = 24 \text{ MHz}$.

1.3 Block Diagram

Figure 1.1 is a block diagram of the M16C/28 Group (M16C/28, M16C/28B), 80-pin and 85-pin package.

Figure 1.2 is a block diagram of the M16C/28 Group (M16C/28, M16C/28B), 64-pin package.

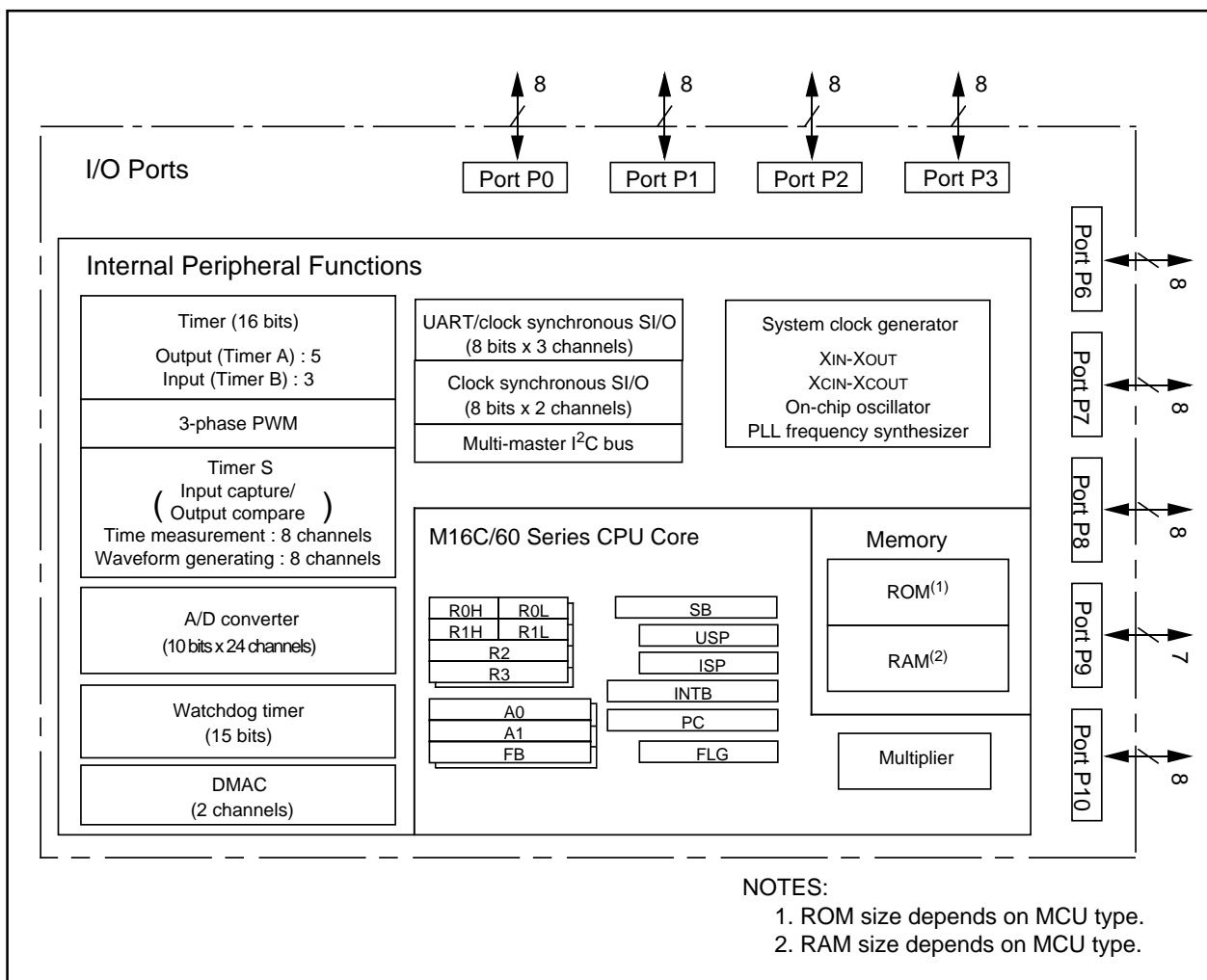


Figure 1.1 M16C/28 Group (M16C/28, M16C/28B), 80-Pin/85-Pin Block Diagram

1.4 Product Information

Tables 1.3 and 1.4 list the M16C/28 Group product information and Figure 1.3 shows the product numbering system. The specifications are partially different between normal-ver. and T/ V-ver..

Table 1.3 M16C/28 Product List -Normal-ver.

As of September, 2006

Type Number	ROM Capacity	RAM Capacity	Package Type	Remarks	Product Code
M30280F6WG (N)	48 K + 4 K	4 K	PTLG0085JB-A (85F0G)	Flash Memory	U3, U5, U7, U9
M30280F8WG (N)	64 K + 4 K	4 K			
M30280FAWG (N)	96 K + 4 K	8 K			
M30280F6HP (N)	48 K + 4 K	4 K	PLQP0080KB-A (80P6Q-A)		
M30280F8HP (N)	64 K + 4 K	4 K			
M30280FAHP (N)	96 K + 4 K	8 K			
M30280FCHP (N)	128 K + 4 K	12 K			
M30281F6HP (N)	48 K + 4 K	4 K	PLQP0064KB-A (64P6Q-A)		
M30281F8HP (N)	64 K + 4 K	4 K			
M30281FAHP (N)	96 K + 4 K	8 K			
M30281FCHP (N)	128 K + 4 K	12 K			
M30280M8-XXXHP (N)	64 K	4 K	PLQP0080KB-A (80P6Q-A)	Mask ROM	U3, U5
M30280MA-XXXHP (N)	96 K	8 K			
M30280MC-XXXHP (N)	128 K	12 K			
M30281M8-XXXHP (N)	64 K	4 K	PLQP0064KB-A (64P6Q-A)		
M30281MA-XXXHP (N)	96 K	8 K			
M30281MC-XXXHP (N)	128 K	12 K			

(N): New

Table 1.4 M16C/28B Product List -Normal-ver.

As of September, 2006

Type Number	ROM Capacity	RAM Capacity	Package Type	Remarks	Product Code
M30280FCBHP (D)	128 K + 4 K	12 K	PLQP0080KB-A (80P6Q-A)	Flash memory	U7
M30281FCBHP (D)	128 K + 4 K	12 K	PLQP0064KB-A (64P6Q-A)		

(D): Under development

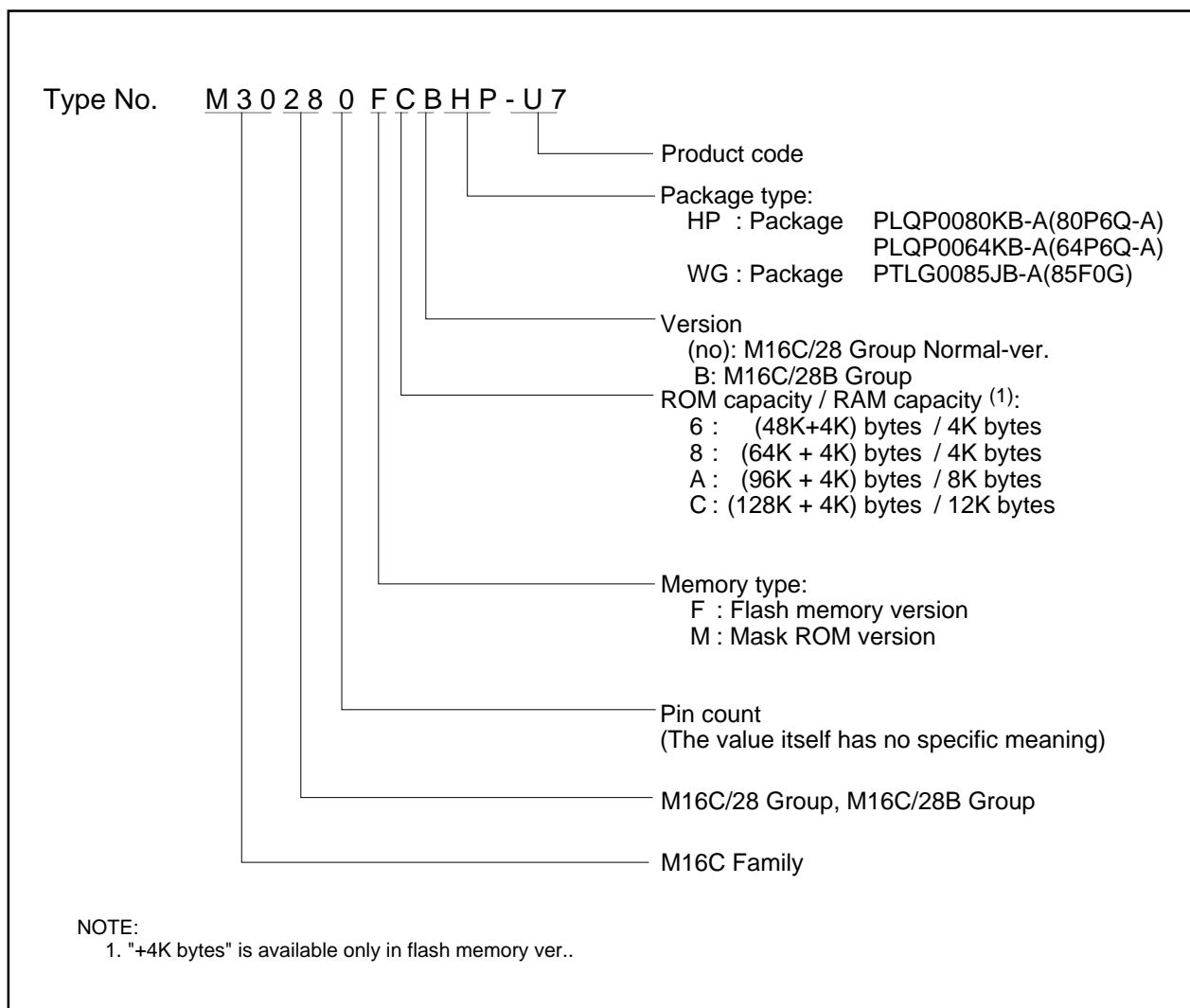


Figure 1.3 Product Numbering System

Table 1.5 Product Code (Flash Memory-ver.) - M16C/28 Normal-ver., 64-Pin⁽¹⁾/80-Pin⁽¹⁾/85-Pin Package

Product Code	Package	Internal ROM (User Program Space)		Internal ROM (Data Space)		Operating Ambient Temperature
		Program and Erase Endurance	Temperature Range	Program and Erase Endurance	Temperature Range	
U3	Lead free	100	0 to 60°C	100	0 to 60°C	-40 to 85°C
U5					-20 to 85°C	
U7		1,000		10,000	-40 to 85°C	-40 to 85°C
U9					-20 to 85°C	-20 to 85°C

NOTE:

1. The lead contained products, D3, D5, D7 and D9, are put together with U3, U5, U7 and U9 respectively. Lead-free (Sn-Ag-Cu plating) products can be mounted by both conventional Sn-Pb paste and Lead-free paste.

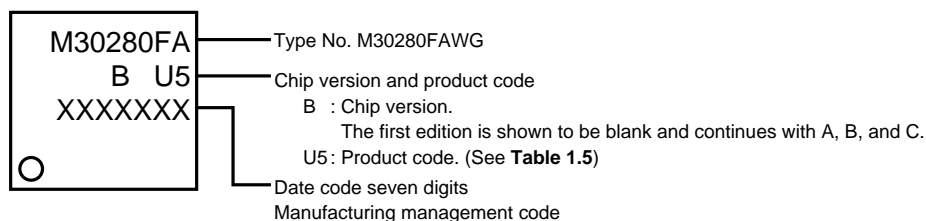
Table 1.6 Product Code (Flash Memory-ver.) - M16C/28B Normal-ver., 64-Pin/85-Pin Package

Product Code	Package	Internal ROM (User Program Space)		Internal ROM (Data Space)		Operating Ambient Temperature
		Program and Erase Endurance	Temperature Range	Program and Erase Endurance	Temperature Range	
U7	Lead-free	1,000	0 to 60°C	10,000	-40 to 85°C	-40 to 85°C

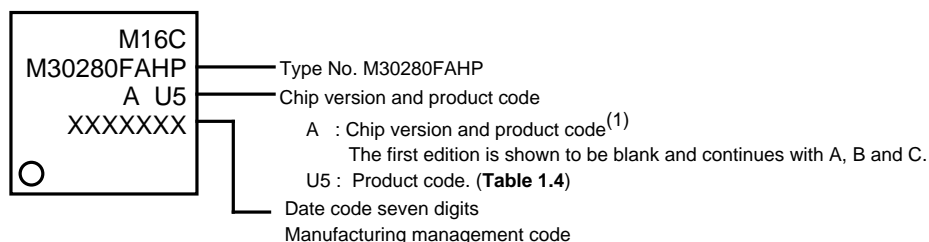
Table 1.7 Product Code (Mask ROM ver.) - M16C/28B Normal-ver., 64-Pin/80-Pin/85-Pin Package

Product Code	Package	Operating Ambient Temperature
U3	Lead-free	-40 to 85°C
U5		-20 to 85°C

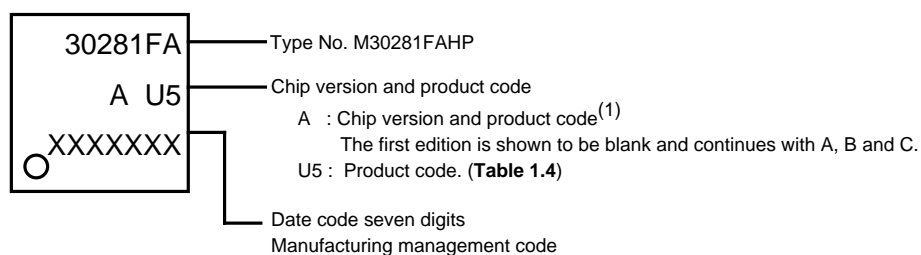
(1) Flash Memory Version, PTLG0085JB-A (85F0G), Normal-ver.



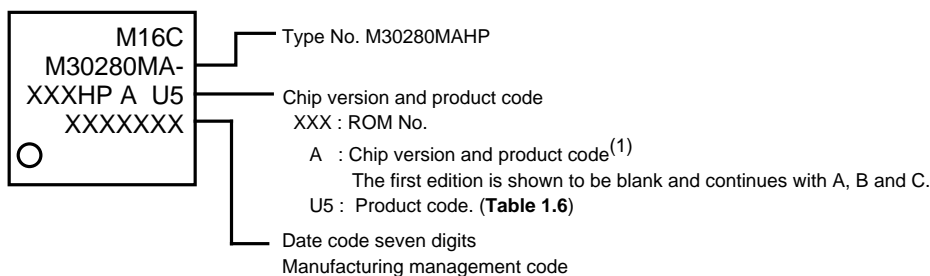
(2) Flash Memory Version, PLQP0080KB-A (80P6Q-A), Normal-ver.



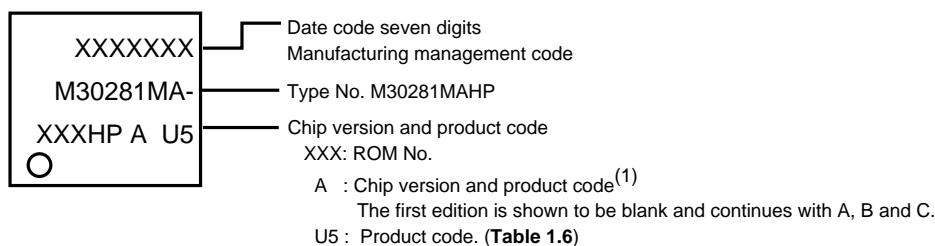
(3) Flash Memory Version, PLQP0064KB-A (64P6Q-A), Normal-ver.



(4) Mask ROM Version, PLQP0080KB-A (80P6Q-A), Normal-ver.



(5) Mask ROM Version, PLQP0064-KB-A (64P6Q-A), Normal-ver.



NOTES:

- The following functions are not available in the first version and version A products.
 - Delay trigger mode 0 of A/D conversion
 - Delay trigger mode 1 of A/D conversion

Figure 1.4 Marking Diagram-M16C/28 Normal-ver.

Table 1.8 Pin Characteristics for 85-pin Package (continued)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	Timer S Pin	UART Pin	Multi-master I ² C bus Pin	Analog Pin	PLQP0080KB-A Pin Number
E8		P15	INT ₃	IDV				ADTRG	54
E9		P16	INT ₄	IDW					53
E10		P17	INT ₅	IDU	INPC17				52
F1	V _{cc}								13
F2	V _{cc}								13
F3		P85	NMI	SD					14
F8	V _{ss} ⁽¹⁾								(11)
F9		P20			OUTC10 / INPC10		SDAMM		51
F10		P21			OUTC11 / INPC11		SCLMM		50
G1		P84	INT ₂	ZP					15
G2		P83	INT ₁						16
G3		P82	INT ₀						17
G8		P22			OUTC12 / INPC12				49
G9		P23			OUTC13 / INPC13				48
G10		P24			OUTC14 / INPC14				47
H1		P81		TA4IN / \bar{U}					18
H2		P80		TA4OUT / U					19
H3		P71		TA0IN		RxD2 / SCL2 / CLK1			26
H4		P66				RxD1			29
H5	V _{ss} ⁽¹⁾								(11)
H6		P35							34
H7		P32				SOUT3			37
H8		P25			OUTC15 / INPC15				46
H9		P26			OUTC16 / INPC16				45
H10		P27			OUTC17 / INPC17				44
J1		P76		TA3OUT					21
J2		P74		TA2OUT / W					23
J3		P72		TA1OUT / V		CLK2 / RxD1			25
J4		P67				TxD1			28
J5		P64				RTS1 / CTS1 / CTS0 / CLKS1			31
J6		P36							33
J7		P33							36
J8		P62				RxD0			41
J9		P60				RTS0 / CTS0			43
J10		P61				CLK0			42
K1		P77		TA3IN					20
K2		P75		TA2IN / \bar{W}					22
K3		P73		TA1IN / \bar{V}		CTS2 / RTS2 / TXD1			24
K4		P70		TA0OUT		TxD2 / SDA2 / RTS1 / CTS1 / CTS0 / CLKS1			27
K5		P65				CLK1			30
K6		P37							32
K7		P34							35
K8		P63				TxD0			40
K9		P30				CLK3			39
K10		P31				SIN3			38

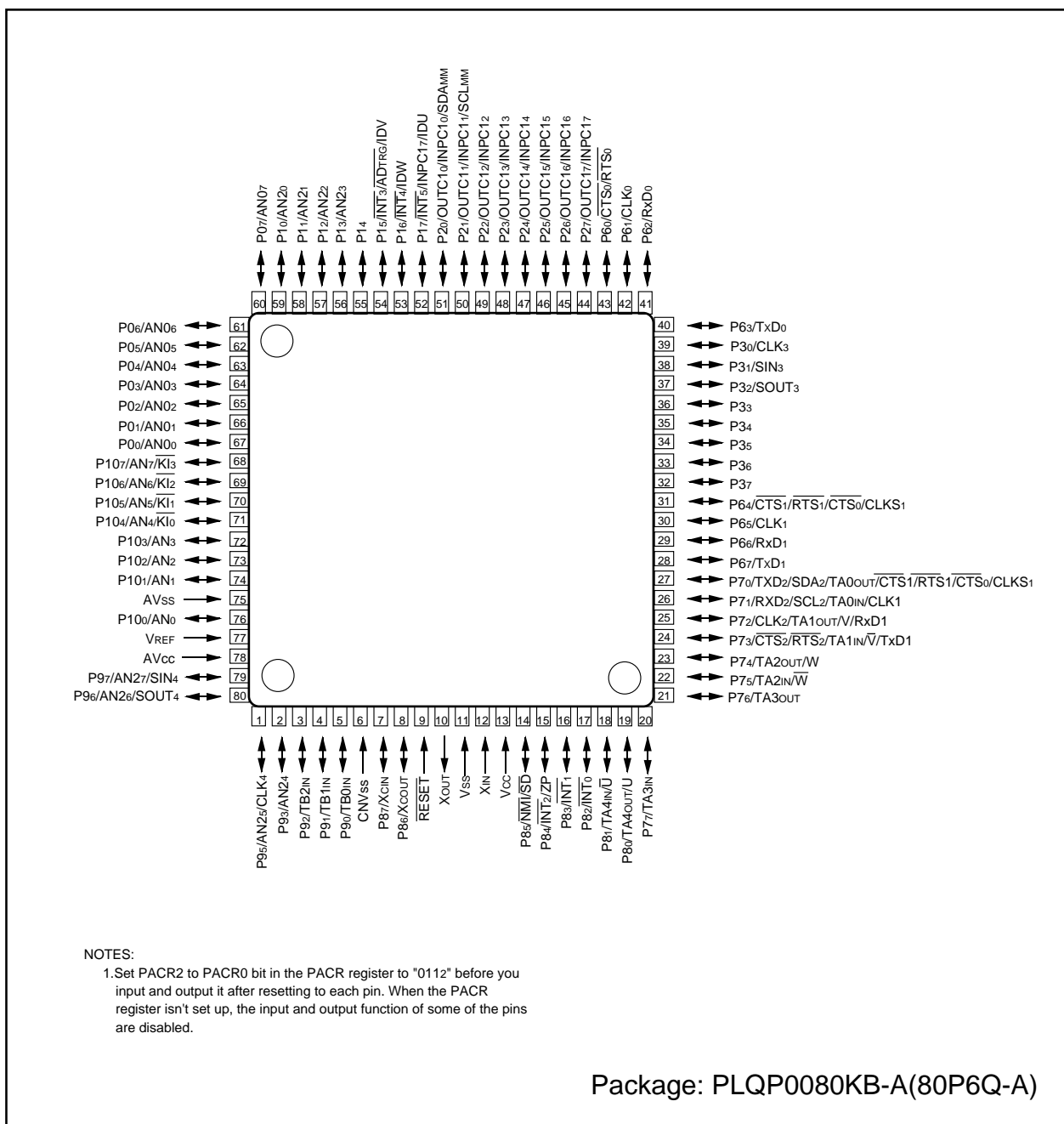


Figure 1.5 Pin Assignment (Top View) of 80-Pin Package

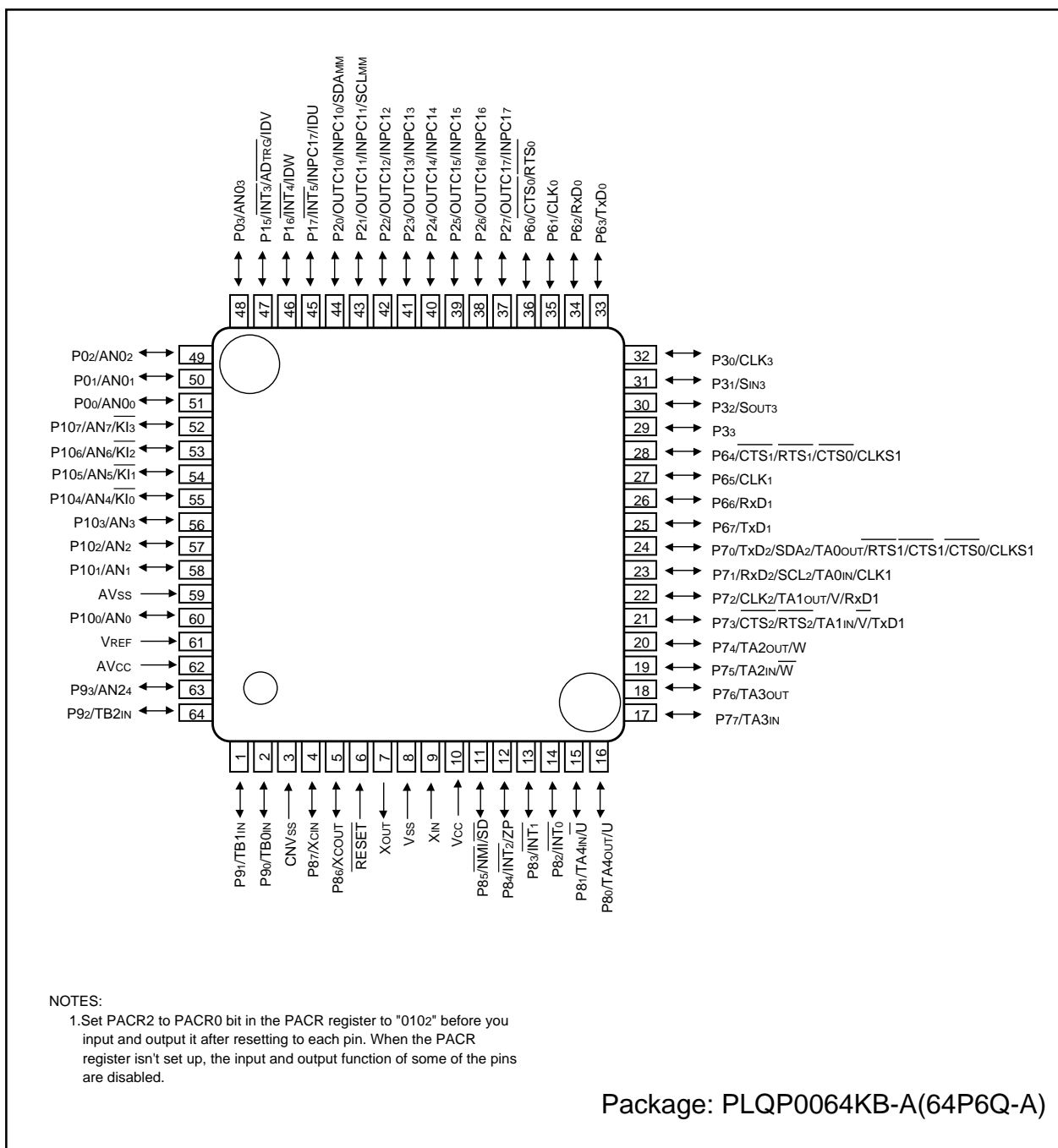


Figure 1.6 Pin Assignment (Top View) of 64-Pin Package

1.6 Pin Description

Table 1.10 Pin Description (64-Pin, 80-Pin and 85-Pin Packages)

Classification	Symbol	I/O Type	Function
Power Supply	VCC, VSS	I	Apply 2.7 to 5.5V to the VCC pin. Apply 0V to the VSS pin.
Analog Power Supply	AVCC AVSS	I	Supplies power to the A/D converter. Connect the AVCC pin to VCC and the AVSS pin to VSS.
Reset Input	RESET	I	The MCU is in a reset state when "L" is applied to the RESET pin
CNVSS	CNVSS	I	Connect the CNVSS pin to VSS.
Main Clock Input	XIN	I	I/O pins for the main clock oscillation circuit. Connect a ceramic resonator or crystal oscillator between XIN and XOUT. To apply external clock, apply it to XIN and leave XOUT open. If XIN is not used (for external oscillator or external clock) connect XIN pin to VCC and leave XOUT open.
Main Clock Output	XOUT	O	
Sub Clock Input	XCIN	I	I/O pins for the sub clock oscillation circuit. Connect a crystal oscillator between XCIN and XOUT.
Sub Clock Output	XCOUT	O	
INT Interrupt Input	INT0 to INT5	I	Input pins for the INT interrupt. INT2 can be used for Timer A Z-phase function.
NMI Interrupt Input	NMI	I	Input pin for the NMI interrupt. NMI cannot be used as I/O port while the three-phase motor control is enabled. Apply a stable "H" to NMI after setting it's direction register to "0" when the three-phase motor control is enabled.
Key Input Interrupt	KI0 to KI3	I	Input pins for the key input interrupt
Timer A	TA0OUT to TA4OUT	I/O	I/O pins for the timer A0 to A4
	TA0IN to TA4IN	I	Input pins for the timer A0 to A4
	ZP	I	Input pin for Z-phase
Timer B	TB0IN to TB2IN	I	Input pins for the timer B0 to B2
Three-phase Motor Control Timer Output	U, \bar{U} , V, \bar{V} , W, \bar{W}	O	Output pins for the three-phase motor control timer
	IDU, IDW, IDV, SD	I/O	Input and output pins for the three-phase motor control timer
Serial I/O	CTS0 to CTS2	I	Input pins for data transmission control
	RTS0 to RTS2	O	Output pins for data reception control
	CLK0 to CLK3	I/O	Inputs and outputs the transfer clock
	RxD0 to RxD2	I	Inputs serial data
	TxD0 to TxD2	O	Outputs serial data
	CLKS1	O	Output pin for transfer clock
I ² C Mode	SDA2	I/O	Inputs and outputs serial data
	SCL2		Inputs and outputs the transfer clock
Multi-master I ² C bus	SDAMM	I/O	Inputs and outputs serial data
	SCLMM		Inputs and outputs the transfer clock
Reference Voltage Input	VREF	I	Applies reference voltage to the A/D converter
A/D Converter	AN0 to AN7 AN00 to AN03 AN24	I	Analog input pins for the A/D converter
	ADTRG		Input pin for an external A/D trigger

I : Input O : Output I/O : Input and output

Table 1.10 Pin Description (64-Pin, 80-Pin and 85-Pin Packages) (Continued)

Classification	Symbol	I/O Type	Function
Timer S	INPC10 to INPC17	I	Input pins for the time measurement function
	OUTC10 to OUTC17	O	Output pins for the waveform generating function
I/O Ports	P00 to P03 P15 to P17 P20 to P27 P30 to P33 P60 to P67 P70 to P77 P80 to P87 P100 to P107	I/O	I/O ports for CMOS. Each port can be programmed for input or output under the control of the direction register. An input port can be set, by program, for a pull-up resistor available or for no pull-up resistor available in 4-bit units
	P90 to P93	I/O	I/O ports having equivalent functions to P0

I : Input O : Output I/O : Input and output

Table 1.10 Pin Description (80-Pin and 85-Pin Packages only) (Continued)

Classification	Symbol	I/O Type	Function
Serial I/O	CLK4	I/O	Inputs and outputs the transfer clock
	SIN4	I	Inputs serial data
	SOUT4	O	Outputs serial data
A/D Converter	AN04 to AN07 AN20 to AN23 AN25 to AN27	I	Analog input pins for the A/D converter
I/O Ports	P04 to P07 P10 to P14 P34 to P37	I/O	I/O ports for CMOS. Each port can be programmed for input or output under the control of the direction register. An input port can be set, by program, for a pull-up resistor available or for no pull-up resistor available in 4-bit units
	P95 to P97	I/O	I/O ports having equivalent functions to P0

I : Input O : Output I/O : Input and output

2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU registers. The register bank is comprised of 7 registers (R0, R1, R2, R3, A0, A1 and FB) out of 13 CPU registers. Two sets of register banks are provided.

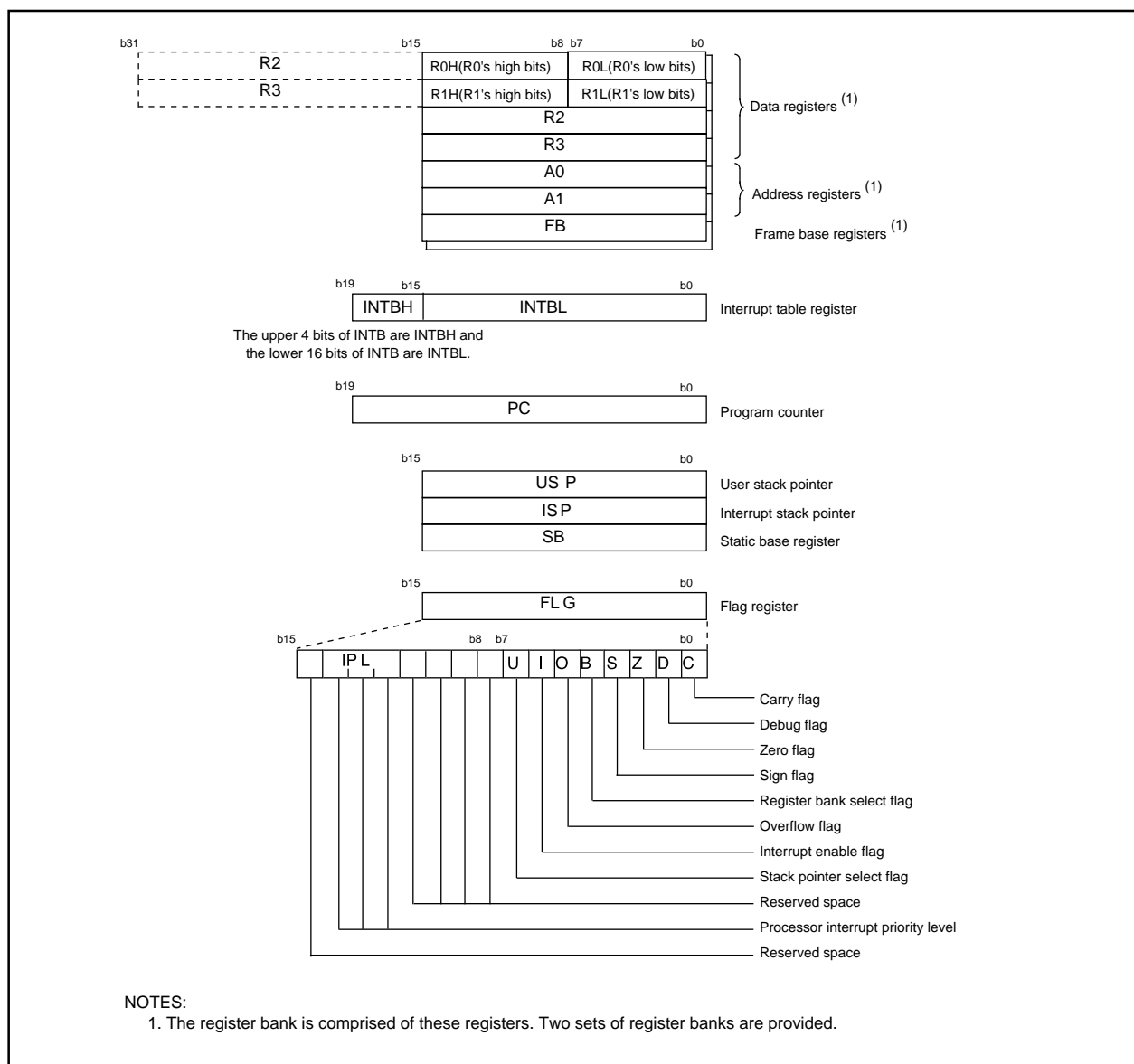


Figure 2.1 Central Processing Unit Register

2.1 Data Registers (R0, R1, R2 and R3)

The R0, R1, R2 and R3 registers are 16 bit registers for transfer and arithmetic/logic operations.

The R0 and R1 registers can be split into high-order bits(R0H, R1H) and low-order bits (R0L, R1L) to be used separately as 8-bit data registers. Conversely, R2 and R0 can be combined with R2 to be used as a 32-bit data register (R2R0). The same applies to R1 and R2.

2.2 Address Registers (A0 and A1)

The register A0 consists of 16 bits, and is used for address register indirect addressing and address register relative addressing. They also are used for transfers and arithmetic/logic operations. A1 is the same as A0. In some instructions, registers A1 and A0 can be combined for use as a 32-bit address register (A1A0).

Table 4.5 SFR Information(5)(1)

Address	Register	Symbol	After Reset
0340 ₁₆			
0341 ₁₆			
0342 ₁₆	Timer A1-1 register	TA11	XX16
0343 ₁₆			XX16
0344 ₁₆	Timer A2-1 register	TA21	XX16
0345 ₁₆			XX16
0346 ₁₆	Timer A4-1 register	TA41	XX16
0347 ₁₆			XX16
0348 ₁₆	Three-phase PWM control register 0	INVC0	0016
0349 ₁₆	Three-phase PWM control register 1	INVC1	0016
034A ₁₆	Three-phase output buffer register 0	IDB0	001111112
034B ₁₆	Three-phase output buffer register 1	IDB1	001111112
034C ₁₆	Dead time timer	DTT	XX16
034D ₁₆	Timer B2 interrupt occurrence frequency set counter	ICTB2	XX16
034E ₁₆	Position-data-retain function control register	PDRF	XXXX00002
034F ₁₆			
0350 ₁₆			
0351 ₁₆			
0352 ₁₆			
0353 ₁₆			
0354 ₁₆			
0355 ₁₆			
0356 ₁₆			
0357 ₁₆			
0358 ₁₆			
0359 ₁₆			
035A ₁₆			
035B ₁₆			
035C ₁₆			
035D ₁₆			
035E ₁₆	Interrupt request cause select register 2	IFSR2A	00XXXXX02 ⁽²⁾
035F ₁₆	Interrupt request cause select register	IFSR	0016
0360 ₁₆	SI/O3 transmit/receive register	S3TRR	XX16
0361 ₁₆			
0362 ₁₆	SI/O3 control register	S3C	010000002
0363 ₁₆	SI/O3 bit rate generator	S3BRG	XX16
0364 ₁₆	SI/O4 transmit/receive register	S4TRR	XX16
0365 ₁₆			
0366 ₁₆	SI/O4 control register	S4C	010000002
0367 ₁₆	SI/O4 bit rate generator	S4BRG	XX16
0368 ₁₆			
0369 ₁₆			
036A ₁₆			
036B ₁₆			
036C ₁₆			
036D ₁₆			
036E ₁₆			
036F ₁₆			
0370 ₁₆			
0371 ₁₆			
0372 ₁₆			
0373 ₁₆			
0374 ₁₆	UART2 special mode register 4	U2SMR4	0016
0375 ₁₆	UART2 special mode register 3	U2SMR3	000X0X0X2
0376 ₁₆	UART2 special mode register 2	U2SMR2	X00000002
0377 ₁₆	UART2 special mode register	U2SMR	X00000002
0378 ₁₆	UART2 transmit/receive mode register	U2MR	0016
0379 ₁₆	UART2 bit rate generator	U2BRG	XX16
037A ₁₆	UART2 transmit buffer register	U2TB	XX16
037B ₁₆			XX16
037C ₁₆	UART2 transmit/receive control register 0	U2C0	000010002
037D ₁₆	UART2 transmit/receive control register 1	U2C1	000000102
037E ₁₆	UART2 receive buffer register	U2RB	XX16
037F ₁₆			XX16

Note 1: The blank spaces are reserved. No access is allowed.

Note 2: Write 1 to bit 0 after reset.

X : Undefined

Table 4.6 SFR Information(6)⁽¹⁾

Address	Register	Symbol	After Reset
0380 ₁₆	Count start flag	TABSR	0016
0381 ₁₆	Clock prescaler reset flag	CPSRF	0XXXXXX2
0382 ₁₆	One-shot start flag	ONSF	0016
0383 ₁₆	Trigger select register	TRGSR	0016
0384 ₁₆	Up-down flag	UDF	0016
0385 ₁₆			
0386 ₁₆	Timer A0 register	TA0	XX16
0387 ₁₆			XX16
0388 ₁₆	Timer A1 register	TA1	XX16
0389 ₁₆			XX16
038A ₁₆	Timer A2 register	TA2	XX16
038B ₁₆			XX16
038C ₁₆	Timer A3 register	TA3	XX16
038D ₁₆			XX16
038E ₁₆	Timer A4 register	TA4	XX16
038F ₁₆			XX16
0390 ₁₆	Timer B0 register	TB0	XX16
0391 ₁₆			XX16
0392 ₁₆	Timer B1 register	TB1	XX16
0393 ₁₆			XX16
0394 ₁₆	Timer B2 register	TB2	XX16
0395 ₁₆			XX16
0396 ₁₆	Timer A0 mode register	TA0MR	0016
0397 ₁₆	Timer A1 mode register	TA1MR	0016
0398 ₁₆	Timer A2 mode register	TA2MR	0016
0399 ₁₆	Timer A3 mode register	TA3MR	0016
039A ₁₆	Timer A4 mode register	TA4MR	0016
039B ₁₆	Timer B0 mode register	TB0MR	00XX00002
039C ₁₆	Timer B1 mode register	TB1MR	00XX00002
039D ₁₆	Timer B2 mode register	TB2MR	00XX00002
039E ₁₆	Timer B2 special mode register	TB2SC	X00000002
039F ₁₆			
03A0 ₁₆	UART0 transmit/receive mode register	U0MR	0016
03A1 ₁₆	UART0 bit rate generator	U0BRG	XX16
03A2 ₁₆	UART0 transmit buffer register	U0TB	XX16
03A3 ₁₆			XX16
03A4 ₁₆	UART0 transmit/receive control register 0	U0C0	000010002
03A5 ₁₆	UART0 transmit/receive control register 1	U0C1	000000102
03A6 ₁₆	UART0 receive buffer register	U0RB	XX16
03A7 ₁₆			XX16
03A8 ₁₆	UART1 transmit/receive mode register	U1MR	0016
03A9 ₁₆	UART1 bit rate generator	U1BRG	XX16
03AA ₁₆	UART1 transmit buffer register	U1TB	XX16
03AB ₁₆			XX16
03AC ₁₆	UART1 transmit/receive control register 0	U1C0	000010002
03AD ₁₆	UART1 transmit/receive control register 1	U1C1	000000102
03AE ₁₆	UART1 receive buffer register	U1RB	XX16
03AF ₁₆			XX16
03B0 ₁₆	UART transmit/receive control register 2	UCON	X00000002
03B1 ₁₆			
03B2 ₁₆			
03B3 ₁₆			
03B4 ₁₆			
03B5 ₁₆			
03B6 ₁₆			
03B7 ₁₆			
03B8 ₁₆	DMA0 request cause select register	DM0SL	0016
03B9 ₁₆			
03BA ₁₆	DMA1 request cause select register	DM1SL	0016
03BB ₁₆			
03BC ₁₆			
03BD ₁₆			
03BE ₁₆			
03BF ₁₆			

Note 1: The blank spaces are reserved. No access is allowed.

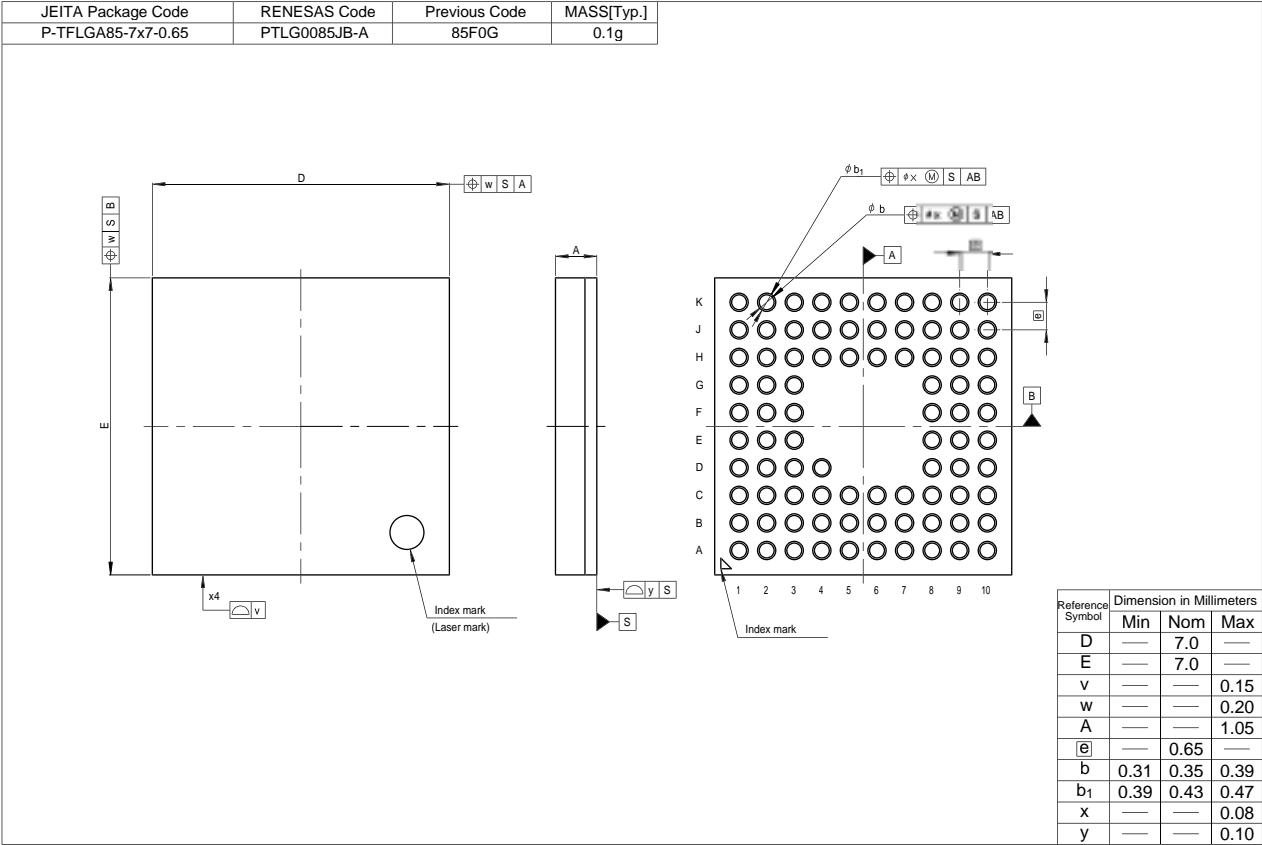
X : Undefined

Table 4.7 SFR Information(7)(1)

Address	Register	Symbol	After Reset
03C0 ₁₆ 03C1 ₁₆	A/D register 0	AD0	XX16 XX16
03C2 ₁₆ 03C3 ₁₆	A/D register 1	AD1	XX16 XX16
03C4 ₁₆ 03C5 ₁₆	A/D register 2	AD2	XX16 XX16
03C6 ₁₆ 03C7 ₁₆	A/D register 3	AD3	XX16 XX16
03C8 ₁₆ 03C9 ₁₆	A/D register 4	AD4	XX16 XX16
03CA ₁₆ 03CB ₁₆	A/D register 5	AD5	XX16 XX16
03CC ₁₆ 03CD ₁₆	A/D register 6	AD6	XX16 XX16
03CE ₁₆ 03CF ₁₆	A/D register 7	AD7	XX16 XX16
03D0 ₁₆			
03D1 ₁₆			
03D2 ₁₆	A/D trigger control register	ADTRGCON	0016
03D3 ₁₆	A/D convert status register 0	ADSTAT0	00000X002
03D4 ₁₆	A/D control register 2	ADCON2	0016
03D5 ₁₆			
03D6 ₁₆	A/D control register 0	ADCON0	00000XXX2
03D7 ₁₆	A/D control register 1	ADCON1	0016
03D8 ₁₆			
03D9 ₁₆			
03DA ₁₆			
03DB ₁₆			
03DC ₁₆			
03DD ₁₆			
03DE ₁₆			
03DF ₁₆			
03E0 ₁₆	Port P0 register	P0	XX16
03E1 ₁₆	Port P1 register	P1	XX16
03E2 ₁₆	Port P0 direction register	PD0	0016
03E3 ₁₆	Port P1 direction register	PD1	0016
03E4 ₁₆	Port P2 register	P2	XX16
03E5 ₁₆	Port P3 register	P3	XX16
03E6 ₁₆	Port P2 direction register	PD2	0016
03E7 ₁₆	Port P3 direction register	PD3	0016
03E8 ₁₆			
03E9 ₁₆			
03EA ₁₆			
03EB ₁₆			
03EC ₁₆	Port P6 register	P6	XX16
03ED ₁₆	Port P7 register	P7	XX16
03EE ₁₆	Port P6 direction register	PD6	0016
03EF ₁₆	Port P7 direction register	PD7	0016
03F0 ₁₆	Port P8 register	P8	XX16
03F1 ₁₆	Port P9 register	P9	XX16
03F2 ₁₆	Port P8 direction register	PD8	0016
03F3 ₁₆	Port P9 direction register	PD9	000X00002
03F4 ₁₆	Port P10 register	P10	XX16
03F5 ₁₆			
03F6 ₁₆	Port P10 direction register	PD10	0016
03F7 ₁₆			
03F8 ₁₆			
03F9 ₁₆			
03FA ₁₆			
03FB ₁₆			
03FC ₁₆	Pull-up control register 0	PUR0	0016
03FD ₁₆	Pull-up control register 1	PUR1	0016
03FE ₁₆	Pull-up control register 2	PUR2	0016
03FF ₁₆	Port control register	PCR	0016

Note 1: The blank spaces are reserved. No access is allowed.

X : Undefined



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